

AO4485 40V P-Channel MOSFET

General Description

The AO4485 uses advanced trench technology to provide excellent $R_{\text{DS(ON)}}$ with low gate charge. This device is suitable for use as a DC-DC converter application.

Product Summary

 $V_{DS}(V) = -40V$

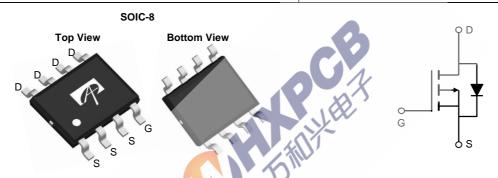
 $I_D = -10A$ $(V_{GS} = -10V)$

 $R_{DS(ON)} < 15 m\Omega \qquad (V_{GS} = -10 V)$

 $R_{DS(ON)} < 20 m\Omega$ (V_{GS} = -4.5V)

100% UIS Tested 100% Rg Tested





Absolute Maximum Ratings T_J=25℃ unless otherwise noted

Parameter		Symbol	10 Sec	Steady State	Units	
Drain-Source Voltage		V_{DS}	-40		V	
Gate-Source Voltage		V_{GS}	±20		V	
Continuous Drain	T _A =25℃		-12	-10		
Current ^A	T _A =70℃	I _D	-9	-8	۸	
Pulsed Drain Current ^B		I _{DM}	-120		A	
Avalanche Current ^G		I _{AR}	-28			
Repetitive avalanche energy L=0.3mH ^G		E _{AR}	118		mJ	
Power Dissipation ^A	T _A =25℃	D	3.1	1.7	W	
	T _A =70℃	$-P_{D}$	2.0	1.1	VV	
Junction and Storage Temperature Range		T _J , T _{STG}	-55 to 150		C	

Thermal Characteristics								
Parameter	Symbol	Тур	Max	Units				
Maximum Junction-to-Ambient A	t ≤ 10s	t ≤ 10s		40	℃/W			
Maximum Junction-to-Ambient A	Steady State	$R_{ hetaJA}$	59	75	°C/W			
Maximum Junction-to-Lead ^C	Steady State	$R_{ hetaJL}$	16	24	C\M			

Electrical Characteristics (T_J=25℃ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Units			
STATIC PARAMETERS									
BV _{DSS}	Drain-Source Breakdown Voltage	$I_D = -250 \mu A, V_{GS} = 0 V$	-40			V			
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = -40V, V_{GS} = 0V$			-1				
		$T_{J} =$	55℃		-5	μΑ			
I_{GSS}	Gate-Body leakage current	$V_{DS} = 0V, V_{GS} = \pm 20V$			±100	nA			
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS} I_{D} = -250 \mu A$	-1.7	-1.9	-2.5	V			
$I_{D(ON)}$	On state drain current	$V_{GS} = -10V, V_{DS} = -5V$	-120			Α			
		$V_{GS} = -10V, I_D = -10A$		12.5	15				
R _{DS(ON)}	Static Drain-Source On-Resistance	$T_{J}=1$	125℃	19	23	mΩ			
		$V_{GS} = -4.5V, I_D = -8A$		16	20				
g _{FS}	Forward Transconductance	$V_{DS} = -5V, I_{D} = -10A$		25		S			
V_{SD}	Diode Forward Voltage	$I_S = -1A, V_{GS} = 0V$		-0.7	-1	V			
Is	Maximum Body-Diode Continuous Curr			-3	Α				
DYNAMIC	PARAMETERS								
C _{iss}	Input Capacitance			2500	3000	pF			
C _{oss}	Output Capacitance	V_{GS} =0V, V_{DS} =-20V, f=1MH	Z	260		pF			
C _{rss}	Reverse Transfer Capacitance			180		pF			
R_g	Gate resistance	V_{GS} =0V, V_{DS} =0V, f=1MHz	2.5	4	6	Ω			
SWITCHI	NG PARAMETERS								
Q _g (10V)	Total Gate Charge			42	55	nC			
Q _g (4.5V)	Total Gate Charge	V10V V20V I1	04	18.6		nC			
Q_{gs}	Gate Source Charge	V_{GS} =-10V, V_{DS} =-20V, I_{D} =-1		7		nC			
Q_{gd}	Gate Drain Charge			8.6		nC			
t _{D(on)}	Turn-On DelayTime			9.4		ns			
t _r	Turn-On Rise Time	V_{GS} =-10V, V_{DS} =-20V,		20		ns			
t _{D(off)}	Turn-Off DelayTime	$R_L = 2\Omega$, $R_{GEN} = 3\Omega$		55		ns			
t _f	Turn-Off Fall Time			30	_	ns			
t _{rr}	Body Diode Reverse Recovery Time	I _F =-10A, dI/dt=100A/μs		38	49	ns			
Q _{rr}	Body Diode Reverse Recovery Charge	I _F =-10A, dI/dt=100A/μs		47		nC			

A: The value of R $_{\theta JA}$ is measured with the device mounted on 1in^2 FR-4 board with 2oz. Copper, in a still air environment with $T_A = 25$ °C. The value in any given application depends on the user's specific board design.

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B: Repetitive rating, pulse width limited by junction temperature.

C. The R $_{\theta JA}$ is the sum of the thermal impedence from junction to lead R $_{\theta JL}$ and lead to ambient.

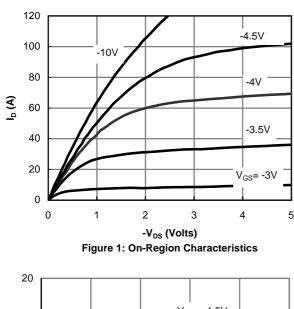
D. The static characteristics in Figures 1 to 6 are obtained using t \le 300 μ s pulses, duty cycle 0.5% max.

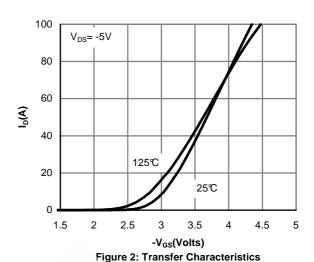
E. These tests are performed with the device mounted on 1 in FR-4 board with 2oz. Copper, in a still air environment with $T_A=25$ °C. The SOA curve provides a single pulse rating.

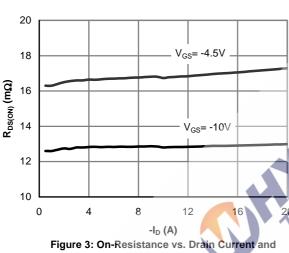
F. The current rating is based on the $t \leqslant 10\text{s}$ thermal resistance rating.

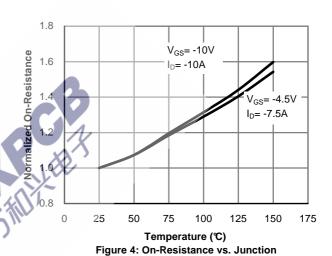
G. E_{AR} and I_{AR} ratings are based on low frequency and duty cycles to keep T_j=25C.

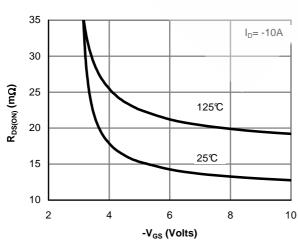
TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



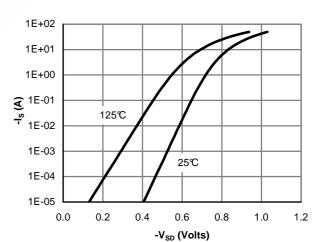








Gate Voltage



Temperature

Figure 5: On-Resistance vs. Gate-Source Voltage

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

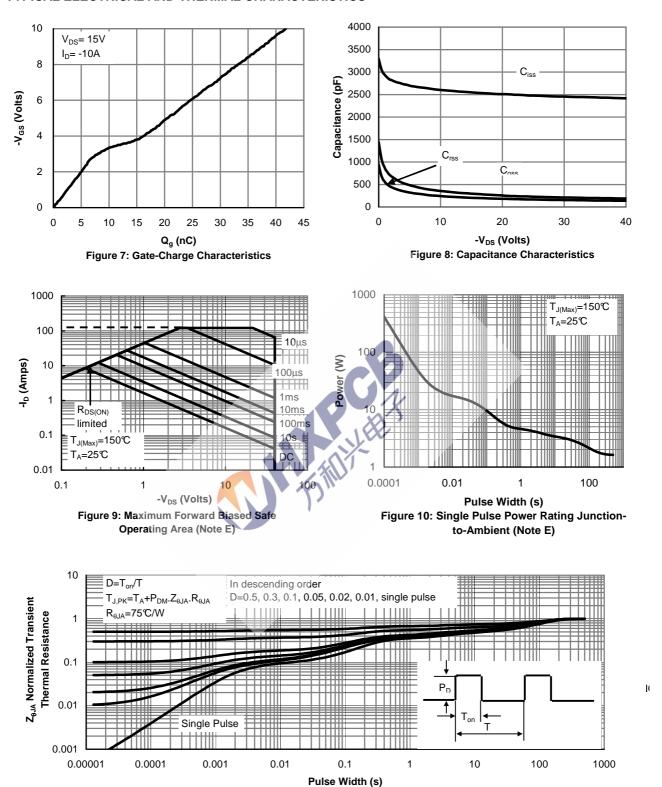


Figure 11: Normalized Maximum Transient Thermal Impedance(Note E)